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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date		
Yoshihiko HANAMAKI	09/25/2006		
Kenichi ONO	09/25/2006		
Masayoshi TAKEMI	09/26/2006		
Makoto TAKADA	09/25/2006		

RECEIVING PARTY DATA

Name:	Mitsubishi Electric Corporation	
Street Address:	7-3, Marunouchi 2-chome	
Internal Address:	Chiyoda-ku	
City:	Tokyo	
State/Country:	JAPAN	
Postal Code:	100-8310	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11549983

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	403824
NAME OF SUBMITTER:	Jeffrey A. Wyand

PATENT

500165276 **REEL: 018399 FRAME: 0115**

Total Attachments: 1 source=403824_Takada_Assignment#page1.tif

PATENT REEL: 018399 FRAME: 0116

ASSIGNMENT

In consideration of the premises and other good and valuable consideration	n ir	hand	paid,	$_{ m the}$	receipt
and sufficiency of which is hereby acknowledged, the undersigned,					

(1) Yoshihiko HANAMAKI (2) Kenichi ONO (3) Masayoshi TAKEMI (4) Makoto TAKADA

who have made a certain new and useful invention, hereby sell, assign and transfer unto

Mitsubishi Electric Corporation 7-3, Marunouchi 2-chome Chiyoda-ku, Tokyo 100-8310 JAPAN

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

Semiconductor Device and Manufacturing Method Therefor

for which an application for United States Letters Patent was executed on even date herewith,

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the international Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

INVENTORS	DATE SIGNED
1) Yoshihiko Idanamaki	September 25th, 2006
Name: Yoshihiko HANAMAKI	
2) Kenichi Omo	September 25th, 2006
Name: Kenichi ONO	
3) Masayoshi Takemi	September 26th, 2006
Name: Masayoshi TAKEMI	
4) Makoto Takada	September 25th, 2006
Name: Makoto TAKADA	,

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RECORDED: 10/17/2006